

7383/R2C3-AMQB/X

Features

- Popular T-1 3/4 round package.
- Choice of various viewing angles.
- Available on tape and reel.
- Reliable and robust.
- ESD-withstand voltage: up to 4KV.
- The product itself will remain within RoHS compliant version.



Descriptions

- The series is specially designed for applications requiring higher brightness.
- The LED lamps are available with different colors, intensities, epoxy colors, etc.

Applications

- Status indicators.
- Advertising Signs.

Commercial use.

Back lighting.

Device Selection Guide

LED Part No.	Chip Mterial	Emitted Color	Lens Color	Stopper
7383/R2C3-AMQB	AlGaInP	Brilliant Red	Water Clear	No
7383/R2C3-AMQB/P	AlGaInP	Brilliant Red	Water Clear	Yes

http\\:www.everlight.com Everlight Electronics Co., Ltd. Rev 2 Page: 1 of 10

Device Number: DLE-0000741 Prepared date:01-13-2009 Prepared: Flourix Chen

Revision Release Date:2009-01-21 08:15:09.0 : 2 LifecyclePhase:正式發行

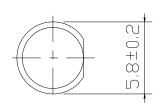
Expired Period: Forever

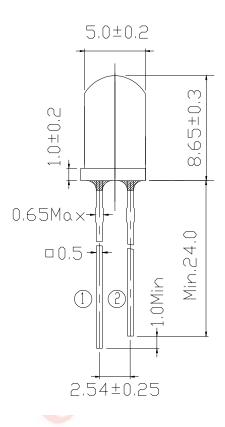


7383/R2C3-AMQB/X

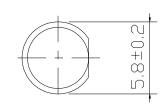
Package Dimensions

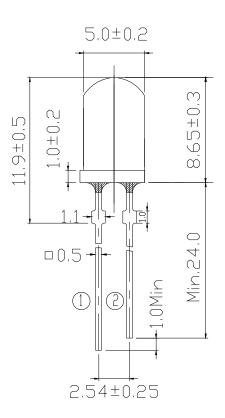
Stopper type

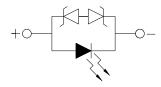




No Stopper type







- ①Anode
- @Cathode

Notes:

- All dimensions are in millimeters, tolerance is 0.25mm except being specified.
- Lead spacing is measured where the lead emerges from the package.
- Protruded resin under flange is 1.5mm Max LED.

Everlight Electronics Co., Ltd.

http\\:www.everlight.com Prepared date:01-13-2009 Page: 2 of 10

Device Number: DLE-0000741

Prepared: Flourix Chen

Rev 2

Revision: 2

Release Date:2009-01-21 08:15:09.0



7383/R2C3-AMQB/X

Absolute Maximum Ratings (Ta=25)

Parameter	Symbol	Rating	Units
Forward Current	I_{F}	50	mA
Pulse Forward Current*1	I_{FP}	160	mA
Operating Temperature	T_{opr}	-40 ~ +85	
Storage Temperature	T_{stg}	-40 ~ +100	
Electrostatic Discharge	ESD	4K	V
Soldering Temperature*2	T_{sol}	260	
Power Dissipation	P_d	120	mW
Zener Reverse Current	Iz	100	mA
Reverse Voltage	VR	5	V

Notes: *1:I_{FP} Conditions--Pulse Width 10msec and Duty 1/10.

Electro-Optical Characteristics (Ta=25)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Units
Forward Voltage	V_{F}	I _F =20mA	1.8	2.0	2.6	V
Zener Reverse Voltage	Vz	I _Z =5mA	5.2	17.		V
Luminous Intensity	I_{V}	I _F =20mA	2850	4500	7150	mcd
Viewing Angle	2 1/2	I _F =20mA		30		deg
Peak Wavelength	p	I _F =20mA		632		nm
Dominant Wavelength	d	I _F =20mA	618	624	628	nm
Spectrum Radiation Bandwidth		I _F =20mA		20		nm
Reverse Current	I_R	$V_R=5V$			50	μΑ

Everlight Electronics Co., Ltd. http\\:www.everlight.com Rev 2 Page: 3 of 10

Device Number : DLE-0000741 Prepared date:01-13-2009 Prepared : Flourix Chen Release Date:2009-01-21 08:15:09.0

^{*2:}Soldering time 5 seconds.



7383/R2C3-AMQB/X

Rank Combination (I_F=20mA)

Rank	P	Q	R	S
Luminous Intensity	2850~3600	3600~4500	4500~5650	5650~7150

^{*}Measurement Uncertainty of Luminous Intensity: ±10%

Unit: :mcd

Rank	1	2	3	4
Forward Voltage	1.8~2.0	2.0~2.2	2.2~2.4	2.4~2.6

^{*}Measurement Uncertainty of Forward Voltage: ±0.1V

Unit:V

Rank	1	2	3
Dominant Wavelength	618~620	620~624	624~628

^{*}Measurement Uncertainty of Dominant Wavelength ±1.0nm

Unit:nm

COMPIDEINA

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http\\:www.everlight.com Prepared date:01-13-2009

Prepared : Flourix Chen

Device Number : DLE-0000741 Revision : 2

Release Date:2009-01-21 08:15:09.0

Page: 4 of 10

Expired Period: Forever

Rev 2

LifecyclePhase:正式發行

^{*}The quantity ratio of the ranks is decided by EVERLIGHT.



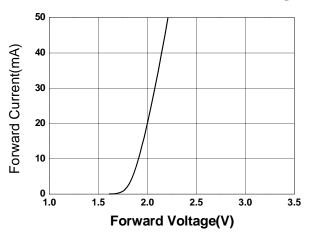
7383/R2C3-AMQB/X

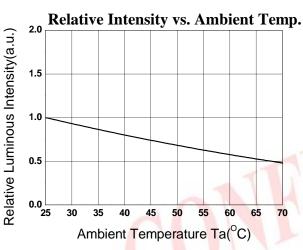
Typical Electro-Optical Characteristics Curves

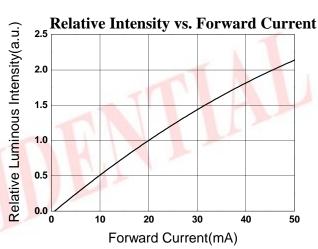
Relative Intensity vs. Wavelength

1.0 Relative Intensity(a.u.) 0.8 0.6 0.4 0.2 0.0 450 500 550 600 650 700 Wavelength(nm)

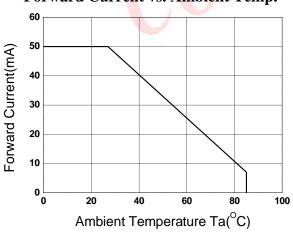
Forward Current vs. Forward Voltage

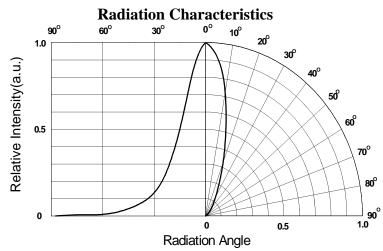






Forward Current vs. Ambient Temp.





Everlight Electronics Co., Ltd.

Device Number: DLE-0000741

Revision : 2

LifecyclePhase:正式發行

http\\:www.everlight.com

Prepared date:01-13-2009

Rev 2

Page: 5 of 10

Prepared: Flourix Chen

Release Date: 2009-01-21 08:15:09.0

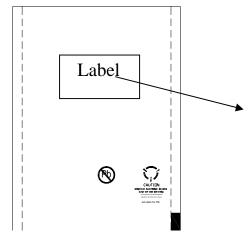
Expired Period: Forever



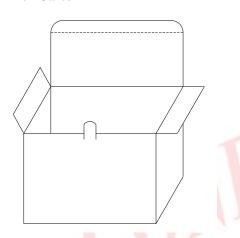
7383/R2C3-AMQB/X

Packing Specification

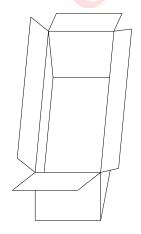
Anti-electrostatic bag



Inner Carton



Outside Carton





Label Form Specification

CPN: Customer's Production Number

P/N : Production Number QTY: Packing Quantity

CAT: Rank of Luminous Intensity and Forward Voltage

HUE: Rank of Dominant Wavelength

REF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

Packing Quantity

1. 500 PCS/1 Bag, 5 Bags/1 Inner Carton

2. 10 Inner Cartons/1 Outside Carton

Everlight Electronics Co., Ltd.

Device Number: DLE-0000741

Revision: 2

LifecyclePhase:正式發行

http\\:www.everlight.com

Prepared date:01-13-2009

Rev 2

Page: 6 of 10

Prepared: Flourix Chen

Release Date:2009-01-21 08:15:09.0

Expired Period: Forever



7383/R2C3-AMQB/X

Notes

1. Lead Forming

- During lead formation, the leads should be bent at a point at least 3mm from the base of the epoxy bulb.
- Lead forming should be done before soldering.
- Avoid stressing the LED package during leads forming. The stress to the base may damage the LED's characteristics or it may break the LEDs.
- Cut the LED leadframes at room temperature. Cutting the leadframes at high temperatures may cause failure of the LEDs.
- When mounting the LEDs onto a PCB, the PCB holes must be aligned exactly with the lead position of the LED. If the LEDs are mounted with stress at the leads, it causes deterioration of the epoxy resin and this will degrade the LEDs.

2. Storage

- The LEDs should be stored at 30°C or less and 70%RH or less after being shipped from Everlight and the storage life limits are 3 months. If the LEDs are stored for 3 months or more, they can be stored for a year in a sealed container with a nitrogen atmosphere and moisture absorbent material.
- Please avoid rapid transitions in ambient temperature, especially, in high humidity environments where condensation can occur.

3. Soldering

- Careful attention should be paid during soldering. When soldering, leave more then 3mm from solder joint to epoxy bulb, and soldering beyond the base of the tie bar is recommended.
- Recommended soldering conditions:

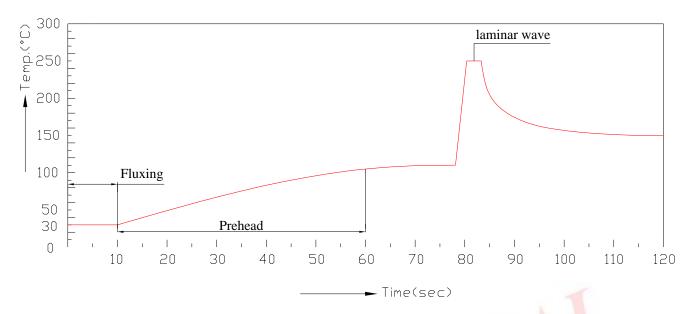
Hand Soldering		DIP Soldering		
Temp. at tip of iron	300 Max. (30W Max.)	Preheat temp.	100 Max. (60 sec Max.)	
Soldering time	3 sec Max.	Bath temp. & time	260 Max., 5 sec Max	
Distance	3mm Min.(From solder joint to epoxy bulb)	Distance	3mm Min. (From solder joint to epoxy bulb)	

Everlight Electronics Co., Ltd. http\\:www.everlight.com Rev 2 Page: 7 of 10

Device Number : DLE-0000741 Prepared date:01-13-2009 Prepared : Flourix Chen Revision : 2 Release Date:2009-01-21 08:15:09.0



7383/R2C3-AMQB/X



- Avoiding applying any stress to the lead frame while the LEDs are at high temperature particularly when soldering.
- Dip and hand soldering should not be done more than one time
- After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.
- A rapid-rate process is not recommended for cooling the LEDs down from the peak temperature.
- Although the recommended soldering conditions are specified in the above table, dip or handsoldering at the lowest possible temperature is desirable for the LEDs.
- Wave soldering parameter must be set and maintain according to recommended temperature and dwell time in the solder wave.

4. Cleaning

When necessary, cleaning should occur only with isopropyl alcohol at room temperature for a duration of no more than one minute. Dry at room temperature before use.

Everlight Electronics Co., Ltd.

Device Number: DLE-0000741

http\\:www.everlight.com Prepared date:01-13-2009

Prepared : Flourix Chen

Page: 8 of 10

Revision: 2

Release Date:2009-01-21 08:15:09.0

Expired Period: Forever

Rev 2



7383/R2C3-AMQB/X

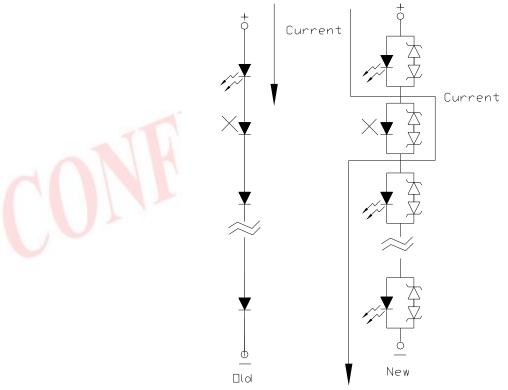
Page: 9 of 10

Rev 2

■ Do not clean the LEDs by the ultrasonic. When it is absolutely necessary, the influence of ultrasonic cleaning on the LEDs depends on factors such as ultrasonic power and the assembled condition. Ultrasonic cleaning shall be pre-qualified to ensure this will not cause damage to the LED

5. Circuit Protection

- Below the zener reference voltage Vz, all the current flows through LED and as the voltage rises to Vz, the zener diode "breakdown." If the voltage tries to rise above Vz current flows through the zener branch to keep the voltage at exactly Vz.
- When the LED is connected using serial circuit, if either piece of LED is no light up but current can't flow through causing others to light down. In new design, the LED is parallel with zener diode. if either piece of LED is no light up but current can flow through causing others to light up.



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Device Number : DLE-0000741 Prepared date:01-13-2009 Prepared : Flourix Chen

Release Date:2009-01-21 08:15:09.0

Revision : 2 Release Date:2009-01-21 08:1 LifecyclePhase:正式發行 Expired Period: Forever



7383/R2C3-AMQB/X

6. Heat Management

- Heat management of LEDs must be taken into consideration during the design stage of LED application. The current should be de-rated appropriately by referring to the de-rating curve found in each product specification.
- The temperature surrounding the LED in the application should be controlled. Please refer to the data sheet de-rating curve.

7. ESD (Electrostatic Discharge)

- Electrostatic discharge (ESD) or surge current (EOS) can damage LEDs.
- An ESD wrist strap, ESD shoe strap or antistatic gloves must be worn whenever handling LEDs.
- All devices, equipment and machinery must be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LEDs plastic lens as a result of friction between LEDs during storage and handing.

8. Other

- Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
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Everlight Electronics Co., Ltd. http\\:www.everlight.com Rev 2 Page: 10 of 10

Device Number: DLE-0000741 Prepared date:01-13-2009 Prepared: Flourix Chen

Revision : 2 Release Date:2009-01-21 08:15:09.0